

# AMP DISPLAY INC.

# **SPECIFICATIONS**

# 5.7-in COLOR TFT MODULE

CUSTOMER:					
CUSTOMER PART NO.					
AMP DISPLAY PART NO.	AM-320240N1TMQW-W0H(R)				
APPROVED BY:					
DATE:					
APPROVED FOR SPECIFICATIONS APPROVED FOR SPECIFICATION AND PROTOTYPES					

# **AMP DISPLAY INC**

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# RECORD OF REVISION

Revision Date	Page	Contents	Editor
Revision Date 2007/8/15	Page	Contents  New Release TFT LCD controller + FFC ( 8bit 80 interface )	Editor

#### 1 Features

5.7 inch Amorphous-TFT-LCD (Thin Film Transistor Liquid Crystal Display) module. This module is composed of a 5.7" TFT-LCD panel, LCD controller, power driver circuit and backlight unit.

#### 1.1 TFT Panel Feature:

- (1) Construction: 5.7" a-Si color TFT-LCD, White LED / CCFL Backlight and PCB.
- (2) Resolution (pixel): 320(R.G.B) X240
- (3) Number of the Colors: 262K colors (R, G, B 6 bit digital each)
- (4) LCD type: Transmissive Color TFT LCD (normally White)
- (5) Interface: 24 pin pitch 1.0 FFC
- (6) Power Supply Voltage: 3.3V single power input. Built-in power supply circuit.
- (7) Viewing Direction: 6 O'clock (The direction it's hard to be discolored):

#### 1.2 LCD Controller Feature:

- (1) MCU interface 8/9/16/18 bit 80&68 series MCU interface.
- (2) Display RAM size: 640x240x3x6 bits. Ex:320x240 two frame buffer with 262K colors.
- (3) Arbitrary display memory start position selection.
- (4) MCU interface: 8 bit 80 MPU interface.
- (5) 8 bit / 16 bit interface support 65K ( R5G6B5) /262K(R6G6B6) colors data format.
- (6) 9 bit / 18 bit interface support 262K(R6G6B6) colors data format only.

# 2 Physical specifications

Item	Specifications	Unit	
Display resolution(dot)	960 (W) x 240(H)	Mm	
Active area	115.2 (W) x 86.4 (H)	Mm	
Screen size	5.7(Diagonal)	Mm	
Pixel size	120 (W) x 360 (H)	Um	
Color configuration	R.G.B stripe		
Overall dimension	167.0(W)x109.0(H)x13.1(D)	Mm	
Weight	T.B.D	Mg	
Backlight unit	LED		

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# 3 Default Setting & Option

#### Interface :

The user can select the MCU interface by change the Jumper & Resister Array.

	•					
Setting	JP1	RA1	RA2	RA3	RA4	Remark
Interface Type						
80-18Bit interface	1,2 short	2K	OPEN	OPEN	OPEN	
	2,3 open	ohm				
80-16Bit interface	1,2 short	OPEN	2K	OPEN	OPEN	
	2,3 open		ohm			
80-9Bit interface	1,2 short	OPEN	OPEN	2K	OPEN	
	2,3 open			ohm		
80-8Bit interface	1,2 short	OPEN	OPEN	OPEN	2K	Default
	2,3 open				ohm	
68-18Bit interface	1,2 open	2K	OPEN	OPEN	OPEN	
	2,3 short	ohm				
68-16Bit interface	1,2 open	OPEN	2K	OPEN	OPEN	
	2,3 short		ohm			
68-9Bit interface	1,2 open	OPEN	OPEN	2K	OPEN	
	2,3 short			ohm		
68-8Bit interface	1,2 open	OPEN	OPEN	OPEN	2K	
	2,3 short				ohm	

#### Connector

The user can select the connector type.

Option	Support interface	Remark
24 Pin FFC Cable (Pitch1.0x24pin)	80/68 8bit interface only	Default
34Pin Pin Header ( Pitch 2.54 x 34 pin)	80/68 8/9/16/18 bit interface	

#### Touch panel and Touch panel controller:

The user can select the with TP controller or without TP controller.

Pin Define Option	SK/X1	DO/X2	DI/Y1	TPCS/Y2	IRQ	Remark
Without TP	NC	NC	NC	NC	NC	Default
With TP / Without TP controller	X1	X2	Y1	Y2	NC	
With TP / With TP controller	SK	DO	DI	TPCS	IRQ	

If user want to change the default setting for mass production, please contact with Amprie. We'll apply a new P/N for you.

# 4 Electrical specification

#### 4.1 Absolute max. ratings

#### 4.1.1 Electrical Absolute max. ratings

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power voltage	VDD	VSS=0	-0.3	5.5	V	
Input voltege	V <sub>in</sub> .		-0.3	VDD+0.3	V	Note 1

Note1: /CS,/WR,/RD,RS,DB0~DB7

#### 4.1.2 Environmental Absolute max. ratings

	OPER	OPERATING		RAGE	
Item	MIN	MAX	MIN	MAX	Remark
Temperature	-20	70	-30	80	Note2,3,4,5,6,7
Humidity	No	te1	No	te1	
Corrosive Gas	Not Acc	eptable	Not Acceptable		

Note1: Ta <= 40°C: 85% RH max

Ta > 40°C : Absolute humidity must be lower than the humidity of 85%RH at 40°C

Note2 : For storage condition Ta at  $-30^{\circ}$ C < 48h , at  $80^{\circ}$ C < 100h For operating condition Ta at  $-20^{\circ}$ C < 100h

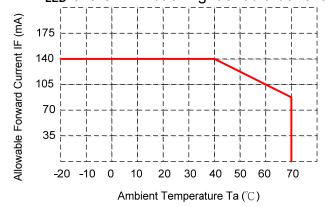
Note3: Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

Note4: The response time will be slower at low temperature.

Note5 : Only operation is guarantied at operating temperature. Contrast , response time, another display quality are evaluated at +25°C

#### Note6:

# • LED BL: When LCM is operated over 40°C ambient temperature, the I<sub>LED</sub> of the LED back-light should be follow:



Note7: This is panel surface temperature, not ambient temperature.

#### Note8:

■ LED BL:When LCM be operated over than 40°C, the life time of the LED back-light will be reduced.

### 4.1.3 LED back-light Unit Absolute max. ratings

Item	Symbol	Ratings	Unit	Remark
Peak forward Current	IF	350	mA	
Reverse Voltage	VR	30	V	
Power Dissipation	Po	1.2	W	

#### 4.2 Electrical characteristics

#### 4.2.1 DC Electrical characteristic of the LCD

Typical operting conditions (VSS=0V)

Item	•	Symbol	Min.	Тур.	Max.	Unit	Remark
Power supp	ly	VDD	3.1	5.0	5.2	V	
Input Voltage for logic	H Level	V <sub>IH</sub> .	2.0	-	5.5	V	Note 1
	L Level	V <sub>IL</sub>	VSS	-	0.8	V	NOIC 1
Output Voltage for Logic	H Level	V <sub>OH</sub> .	2.4	1	VDD	V	Note 2
	L Level	V <sub>OL</sub>	VSS		0.4	V	NOIG Z
Power Supply current		IDD	1	150	1	mA	Note 3

Note1: With 5V Tolerance Input , /CS, /WR,/RD,RS,DB0~DB17

Note2: DB0~DB17

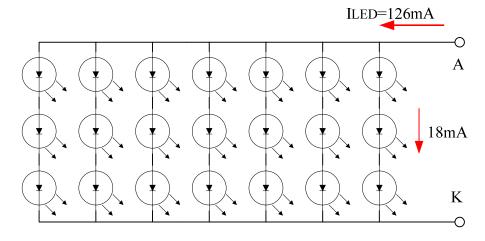
Note3: fv = 60Hz, Ta = 25°C, VDD = 3.3V, DCLK = 10MHz, PLL frequency = 40MHz,

Display pattern : All Black

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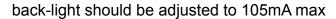
4.2.2 Electrical characteristic of LED Back-light

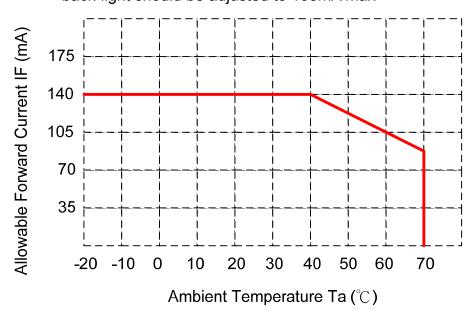
Paramenter	Symbol	Min.	Тур.	Max.	Unit	Condiction
LED voltage	V <sub>AK</sub> .		10.5	12	V	I <sub>LED</sub>
LLD voltage	V.AK.		10.5	12	v	=140mA,Ta=25°C
LED forward current	I.LED.		126	140	mA	Ta=25°C
	I.LED.		84	105	mA	Ta=60°C
l amera life time a	lit ii				l la	I <sub>LED</sub>
Lamp life time		30,000	-	_	Hr	=126mA,Ta=25°C



■ The constant current source is needed for white LED back-light driving.

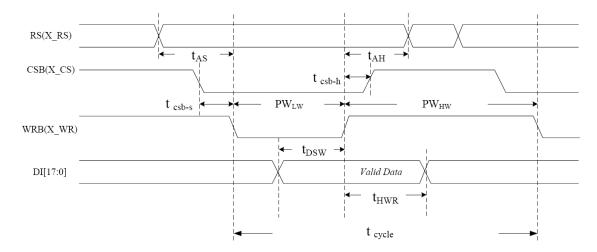
When LCM is operated over 60°C ambient temperature, the I<sub>LED</sub> of the LED





# 3.3 AC Timing characteristic of the Graphic TFT LCD controller

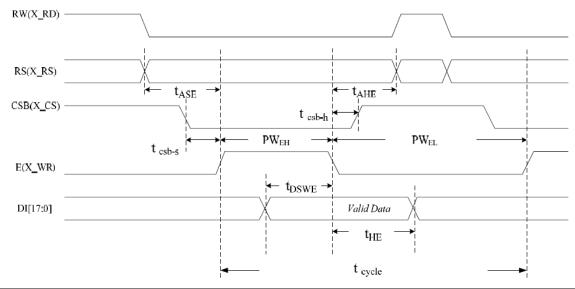
# 4.3 80 series Timing



Symbol	Parameter	Min	Тур	Max	Unit	Remark
tcycle	Enable cycle time	100	200		ns	
<b>PW</b> HW	Enable high-level pulse width	66	70		ns	
<b>PW</b> LW	Enable low-level pulse width	33	130		ns	
tas	RS setup time	16	25		ns	
<b>t</b> AH	RS hold time	16	45		ns	
tosw	Write data setup time	50	50		ns	
thwr	Write data hold time	50	40		ns	
tcsb-s	CSB setup time	16	20		ns	
<b>t</b> csb-h	CSB hold time	16	30		ns	

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# 4.4 68eries Timing



Symbol	Parameter	Min	Тур	Max	Unit	Remark
tcycle	Enable cycle time	100	200		ns	
<b>PW</b> EH	Enable high-level pulse width	66	70		ns	
PWEL	Enable low level pulse width	33	130		ns	
tase	RS setup time	16	25		ns	
<b>t</b> AHE	RS hold time	16	45		ns	
toswe	Write data setup time	50	50		ns	
the	Write data hold time	50	40		ns	
tcsb-s	CSB setup time	16	20		ns	
tcsbh	CSB hold time	16	30		ns	

# 5 Optical specification

### 5.1 Optical characteristic:

Item		Symbol	Conditon	Min.	Тур.	Max.	Unit	Remark
Response	Rise	T <sub>r</sub> .	Θ=0°	-	15	30	ms	Note 1,2,3,5
Time	Fall	T <sub>:f</sub> .		-	35	50	ms	14010 1,2,0,0
Contrast i	ratio	CR	At optimized viewing angle	200	350	-		Note 1,2,4,5
Top Botto				55	60	-		
Viewing			OD > 40	45	50	-	al a a.	Nata 4 0 5 0
Angle	m		CR≧10	55	60	-	deg.	Note1,2, 5,6
	Right			55	60	-		
Brightne LED B		Y.L.	$I_{LED}$ =126mA, $25^{\circ}C$	427.5	450	-	cd/m <sup>2</sup>	Note 7
Without	_	I . <u>L</u> .	$I_{LED}$ =140mA, $25^{\circ}$ C	475	500	-	cd/m <sup>2</sup>	
Pod chrom	aticity	XR		0.610	0.640	0.670		Note 7
Red chrom	alicity	YR		0.314	0.344	0.374		Note 7
Croop obrop	acticity.	XG		0.268	0.298	0.328		For reference
Green chromaticity		YG	Θ=0°	0.553	0.583	0.613		only. These
Rlue chromaticity		Хв	Θ=0°	0.102	0.132	0.162		data should be update
Blue chromaticity		YB		0.107	0.137	0.167		according the
\\/hito obron	noticity.	XW		0.282	0.312	0.342		prototype.
White chron	ialicity	YW		0.299	0.329	0.359		prototype.

( )For reference only. These data should be update according the prototype.

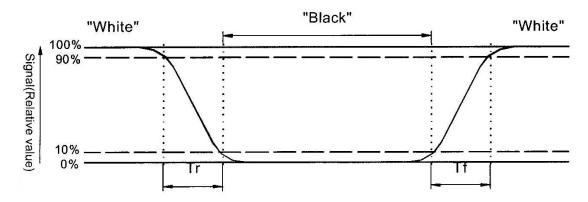
#### Note 1:

- LED BL :Ambient temperature=25<sup>o</sup>C, and lamp current I<sub>LED</sub>=140mA. To be measured in the dark room.
- CCFL BL: Ambient temperature=25<sup>°</sup>C, and lamp current I<sub>L</sub>=6 mArms. To be measured in the dark room.

Note 2:To be measured on the center area of panel with a viewing cone of 1°by Topcon luminance meter BM-7,after 10 minutes operation.

#### Note 3. Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



Note 4. Definition of contrast ratio:

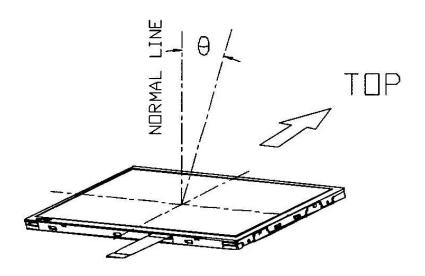
Contrast ratio is calculated with the following formula.

Note 5:White 
$$V_i=V_{i50}+1.5V$$
  
Black  $V_i=V_{i50}+2.0V$ 

"±"means that the analog input signal swings in phase with V<sub>COM</sub> signal.

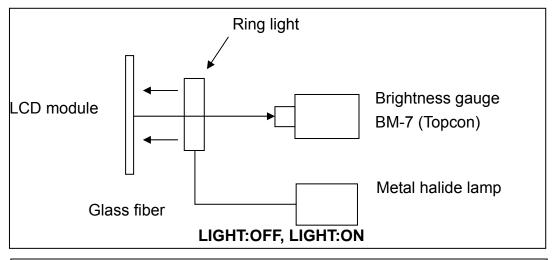
 $V_{\text{i50}}$ : The analog input voltage when transmission is 50%. The 100% Transmission is defined as the transmission of LCD panel when all the Input terminals of module are electrically opened.

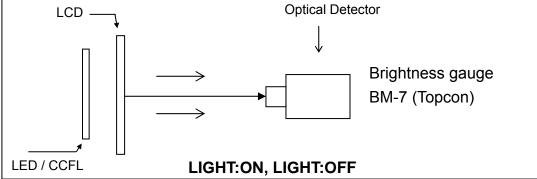
Note 6.Definition of viewing angle, Refer to figure as below.



<sup>&</sup>quot;- " means that the analog input signal swings out of phase with  $V_{\text{COM}}$  signal.

Note 7.Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.





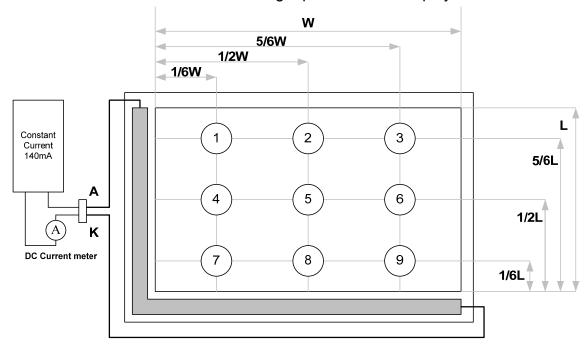
# 5.2 Optical characteristic of the LED Back-light

ITEM	MIN	TYP	MAX	UNIT	Condition
Bare Brightness	3500	1		Cd/m2	I <sub>LED</sub> =140mA,Ta=25°C
AVG. X of 1931 C.I.E.	0.28	0.31	0.34		I <sub>LED</sub> =140mA,Ta=25°C
AVG. X of 1931 C.I.E.	0.28	0.31	0.34		I <sub>LED</sub> =140mA,Ta=25°C
Brightness Uniformity	80			%	I <sub>LED</sub> =140mA,Ta=25°C

( )For reference only. These data should be update according the prototype.

Note1: Measurement after 10 minutes from LED BL operating.

Note2: Measurement of the following 9 places on the display.



Note3: The Uniformity definition (Min Brightness / Max Brightness) x 100%

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# 6 Interface specifications

# 6.1 Driving signals for the TFT panel

# 6.1.1 24pin FFC connector

(Suitable ZIF connector)

Pin no	Symbol	I/O	Description	Remark
1	/RESET	ı	Reset signal for TFT LCD controller	
2	/RD(R/W)		80mode : /RD low active signal for TFT LCD controller	
	/KD(K/W)	ı	68mode : R/W signal Hi: read Lo:Write	
3	/WR(E)		80mode : /WR low active signal for TFT LCD controller	
	` '	'	68mode : E signal latch on rising edge	
4	/CS	ı	Chip select low active signal for TFT LCD controller	
5	RS	ı	Register and Data select for TFT LCD controller	
6	DB0	I/O	Data Bus	
7	DB1	I/O	Data Bus	
8	DB2	I/O	Data Bus	
9	DB3		Data Bus	
10	DB4	I/O	Data Bus	
11	DB5	I/O	Data Bus	
12	DB6	I/O	Data Bus	
13	DB7	I/O	Data Bus	
14	VDD	-	Power supply for the logic (3.3V)	
15	VSS	-	GND	
16	NC	-	No connection	
17	NC	-	No connection	
18	NC	1	No connection	
19	NC	1	No connection	
20	NC	1	No connection	
21	NC	-	No connection	
22	NC	ı	No connection	
23	NC	ı	No connection	
24	NC	-	No connection	

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# 6.1.234pin PIN Header ( Without for reference only)

Pin no	Symbol	Description	
1	/RESET	Reset signal for TFT LCD controller	
3	/RD(R/W)	80mode : /RD low active signal for TFT LCD controller	
	/110(11/77)	68mode : R/W signal Hi: read Lo:Write	
5	/WR(E)	80mode : /WR low active signal for TFT LCD controller	
	/VVIX(L)	68mode : E signal latch on rising edge	
7	/CS	Chip select low active signal for TFT LCD controller	
9	RS	Register and Data select for TFT LCD controller	
11	DB0	Data Bus	
13	DB1	Data Bus	
15	DB2	Data Bus	
17	DB3	Data Bus	
19	DB4	Data Bus	
21	DB5	Data Bus	
23	DB6	Data Bus	
25	DB7	Data Bus	
27	VDD	Power supply for the logic (3.3V)	
29	VDD	Power supply for the logic (3.3V)	
31	VSS	GND	
33	VSS	GND	

Pin no	Symbol	Description
2	NC	No connection
4	NC	No connection
6	NC	No connection
8	NC	No connection
10	NC	No connection
12	DB8	Data Bus
14	DB9	Data Bus
16	DB10	Data Bus
18	DB11	Data Bus
20	DB12	Data Bus
22	DB13	Data Bus
24	DB14	Data Bus
26	DB15	Data Bus
28	DB16	Data Bus
30	DB17	Data Bus
32	NC	No connection
34	NC	No connection

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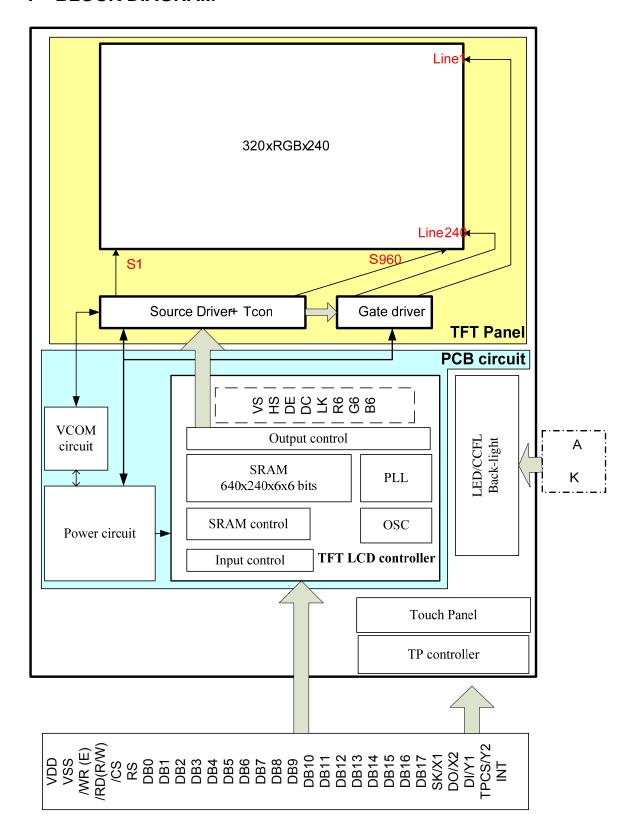
# Driving signals for the back-light

# 6.1.3 LED Back-light

JST Housing: BHR-03VS-1

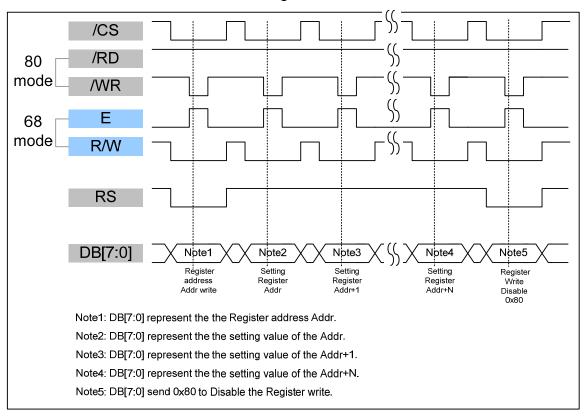
Pin no	Symbol	Level	Description	Remark
1	Α	-	LED Anode	
2	NC	-	No connection	
3	K	-	LED Cathode	

# 7 BLOCK DIAGRAM

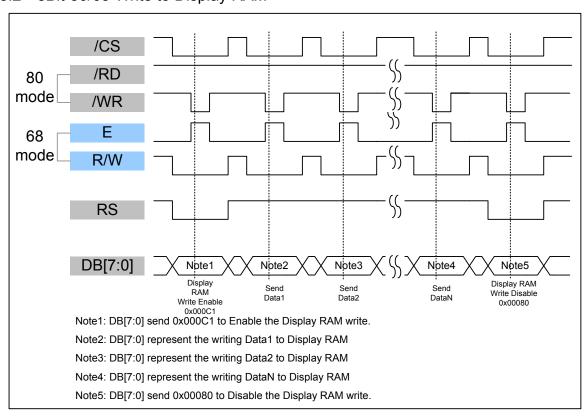


#### 8 Interface Protocol

#### 8.1 8Bit-80/68- Write to Command Register



#### 8.2 8Bit-80/68-Write to Display RAM



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# 8.3 Data transfer order Setting

# 8.3.18 bit interface 65K color (JP2 1,2 short 65K/262K =Low)

DB	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1.st data	Χ	Χ	Χ	Χ	Χ	Χ	Х	Χ	R4	R3	R2	R1	R0	G5	G4	G3
2 <sup>nd</sup> data	Χ	Χ	Χ	Χ	Χ	Χ	Х	Χ	G2	G1	G0	B4	В3	B2	B1	В0

### 8.3.28 bit interface 262K color (JP2 2,3 short 65K/262K =High)

DB	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1.st data	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ							R5	R4
2 <sup>nd</sup> data	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	R3	R2	R1	R0	G5	G4	G3	G2
3. <sup>rd</sup> . data	Х	Х	Х	Χ	Χ	Χ	Х	Χ	G1	G0	B5	B4	B3	B2	B1	B0

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# 9 Register Depiction

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
00	00		<u> </u>	MSB of	X-axis	start p	osition	)			
Description	set the ho	orizonta							l		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
01	00			LSB of	X-axis	start p	osition				
Description	set the ho	orizonta	ıls starl	t positio	on of di	isplay a	active r	egion	1		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
02	01			MSB o	f X-axis	s end p	osition				
Description	set the ho	rizonta							'		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB0	Remark						
03	3F	3F LSB of X-axis end position									
Description	set the ho	set the horizontals end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
04	00		1	MSB of	Y-axis	start p	osition	]			
Description	set the ve	ertical s							Į.		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
05	00			LSB of	Y-axis	start p	osition				
Description	Set the ve	ertical s	tart po	sition c	of displa	ay activ	ve regio	on			
Register Address (Hex)	Default (Hex)	DB7	DB6	DB0	Remark						
06	00		I	MSB o	f Y-axis	s end p	osition				
Description	set the ve	ertical e	nd pos	ition of	displa	y active	e regio	n			
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
07	EF					end p					
Description	Set the vertical end position of display active region										

To simplify the address control of display RAM access, the window area address function

allows for writing data only within a window area of display RAM specified by registers  $REG[00]\sim REG[07]$ .

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After writing data to the display RAM, the Address counter will be increased within setting window address-range which is specified by

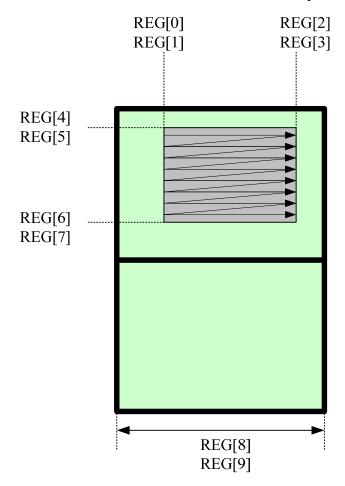
MIN X address (REG[0] & REG[1])

MAX X address (REG[2] & REG[3])

MIN Y address (REG[4] & REG[5])

MAX Y address (REG[6] & REG[7])

Therefore, data can be written consecutively without thinking the data address.



Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
08	01	Х	X	Χ	Х	Χ	Х	_	IXSize te[1:0]		
Description	Set the p	Set the panel X size									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark	
09	40		_PanelXSize L_Byte[7:0]								
Description	Set the panel X size										

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The register REG[08] and REG[09] is use to calculate the RAM address. If you want to use the TFT as Landscape mode (320x240), the REG[08] & RGE[09] must set to 320. If you want to use the TFT as Portrait mode (240x320), the REG[08] & RGE[09] must set to 240.

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0A	00	X	X	X	X	X	memo	:16] bit ory writ addres:		
Description	Memory	write st	art add	Iress						
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0B	00		[15:8]	bits of	memo	ry write	start a	ddress		
Description	Memory	write st	art add	Iress						
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0C	00		[7:0] bits of memory write start address							
Description	Memory write start address									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark			
0x10	0x0D	Bit_SWAP	OUT_TEST	BUS	_SEL	Blanking	P/S_SEL	CLK.	_SEL				
	are for s 00 : 20N "0x10_p	0x10_Clk_sel[1:0]" : The TFT controller built-in 40Mhz PLL clock. These bits re for select the TFT panel dot clock frequency. 0 : 20Mhz 01: 10Mhz 02: 5 Mhz 0x10_ps_sel[2]" : The TFT controller support parallel and serial RGB atterface. These bits are for select the output timing.											
		nterface. These bits are for select the output timing.  : serial Panel 1: Parallel panel											
Description		0 : serial Panel 1: Parallel panel '0x10_blanking_tmp[3]" 0 : OFF (blanking) 1: ON ( normal operation)											
Description	_	us_sel[5: )1=G,10	4]" : It onl	y for se	erial Pa	anel							
	_		4										
		'0x10_out_test[6]" : Self test 0 : normal operation 1: for test (don't use for normal operation)											
		When set the bit to "1", the Rout=(Reg 2a[6:0]) Gout=(Reg 2b[6:0])											
	,	Bout=(Reg 2c[6:0]) "0x10 bit swap[7]" : 0-normal											
	The default setting is suitable for AM320240N1. Don't need to modify it.												

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Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x11	00	Х	Х		EVEN			_ODD		
Description	" Even lii panel 000: RG 001: RB0 010: GR 011: GB 100: BR0 101: BG Others: I	ne of serial of	al panel da		sequer		ata bus d		paralle	el
	100: BR									
	Others:									
	Must Se	et to 0x0	for AM3	<b>20240</b>	N1					

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x12	00					Hsy	nc_st⊦	I_Byte	[3:0]			
Description	For TFT of Hsync state The defail	art posi	tion H-	Byte	for AIV	32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x13	00	· · · · · · · · · · · · · · · · · · ·										
Description	Hsync sta	or TFT output timing adjust: sync start position L-Byte ne default setting is suitable for AM320240N1. Don't need to modify it.										
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x14	00					Hsyr	nc_pwl	I_Byte	[3:0]			
Description	Hsync pu	For TFT output timing adjust:  Hsync pulse width H-Byte  The default setting is suitable for AM320240N1. Don't need to modify it.										
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x15	10	10 Hsync_pwL_Byte[7:0]										

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to any third p	<u>art without</u>	the pri	or writ	ten con	sent of	AMP I	DISPL/	<u> 4 Y</u>				
Description	For TFT of Hsync pu	lse wid	اth L-B	yt <b>é</b>	for AIV	32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x16	00					Had	ct_stH	Byte[	3:0]			
Description	For TFT of DE pulse The defail	start p	osition	H-Byte		32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	Hex) DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Remark										
0x17	38 Hact_stL_Byte[7:0]											
Description	DE pulse	For TFT output timing adjust: DE pulse start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.										
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x18	01					Hac	t_pwH	_Byte	[3:0]			
Description	For TFT of DE pulse The defail	width I	H-Byte		for AIV	32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	(Hex) DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Remark										
0x19	40				t_pwL	_Byte[	7:0]					
Description	For TFT output timing adjust: DE pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.											

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1A	01					Ht	otalH_	Byte[3	:0]	
Description	For TFT of Hsync tot The defar	al cloc	ks H-B	yte	for AN	32024	0N1. D	on't ne	ed to n	nodify it.
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1B	B8	B8 HtotalL_Byte[7:0]								
Description	Hsync tot	For TFT output timing adjust: Hsync total clocks H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.								

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to any time p	Register Default DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Remark											
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x1C	00					Vsv	nc_stH	Bvte	[3:0]			
	For TFT (	output 1	imina	adiust:								
Description	Vsync sta	art posi	tion H-	Byte	for AM	32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address	Default	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
(Hex)	(Hex)											
0x1D	00				nc_stL	_Byte[	7:0]					
Description	For TFT of Vsync state The defail	art posi	tion Ľ-l	3yte	for AM	32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x1É	00											
Description	Vsync pu	For TFT output timing adjust: Vsync pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.										
Register Address (Hex)	Default (Hex)	(Hex) DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Remark										
0x1F	08			Vsyr	nc_pwl	Byte	[7:0]					
Description	For TFT of Vsync pu	lse wid	th L-By	∕te	for AIV	32024	0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x20	00					Vac	ct_stH_	Byte[3	3:01			
Description	For TFT of Vertical Default	E puls	e start	positio			0N1. D	on't ne	ed to n	nodify it.		
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x21	12			Va	ct_stL_	Byte[7	<b>7</b> :0]					
Description	For TFT output timing adjust: Vertical DE pulse start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.											
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark		
0x22	00					Vac	t_pwH	_Byte[	3:0]			
Description	For TFT output timing adjust:  Vertical Active width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.								ed to n	nodify it.		

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	art williout	, till pil	01 11110		gene or	1 11/11 1	101 21			
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x23	F0			Vac	t_pwL	_Byte[	7:0]			
Description	For TFT of Vertical A	ctive w	idth H	-Byte	for AIV	32024	0N1. D	on't ne	ed to n	nodify it.
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x24	01					Vt	otalH_	Byte[3	:0]	
Description	For TFT of Vertical to The defail	otal wic	lth H-B	yte	for AIV	32024	0N1. D	on't ne	ed to n	nodify it.
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x25	09	09 VtotalL_Byte[7:0]								
Description	For TFT of Vertical to The defau	otal wic	Ith L-B	yté	for AIV	32024	0N1. D	on't ne	ed to n	nodify it.

F										
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
26	00	X	X	X	X	X	mem	':16] bit ory read addres:	d start	
Description	Memory	read st	d start address							
Register Address (Hex)	Default (Hex)	DB7	DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 F							
27	00		[15:8]	bits of	memo	ry write	start a	ddress		
Description	Memory	read st	art add	Iress						
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
28	00		[7:0]	bits of	memor	y write s	start ad	Idress		
Description	Memory	emory read start address								

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
29	00			[7:1	] Reve	rsed				
Description	[0] Load effect	d outpu	t timing	relate	d settir	ıg (H syı	nc., V s	sync. ar	nd DE)	to take

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Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2A	00	Χ		-	TestPa <sup>-</sup>	tternRo	out[6:0	]		
Description	When " F The Rou	-		_						
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2B	00	Χ			TestPa <sup>-</sup>	tternG	out[6:0	]		
Description	When " F The Gou									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2C	00	Χ		_	TestPa	tternBo	out[6:0	]		
Description			G[0x10]_out_test[6]" : Self test =1 ; ta equal to TestPatternBout[6:0]							

If you set the "REG[0x10]\_out\_test[6]": Self test =1, the TFT controller will skip the connect of the display RAM. The Output port will send the REG[2A], REG[2B], REG[2C] data.

REG[2A]=0x3F REG[2B]=0x00 REG[2C]=0x00

REG[2A]=0x00 REG[2B]=0x3F REG[2C]=0x00 REG[2A]=0x00 REG[2B]=0x00 REG[2C]=0x3F

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2D	00	Х	X	X	Х	[3]	Rising/falling edge[2]	_	tate :0]	
Description	0: TFT P 1: TFT P Rising/fa 0: The F	POWEF POWEF alling e RGB ou	_ R circui R circui dge[2] It put c	t OFF t ON : lata are	e on th	e Risir	Power ON/OF	DCLK.		
	_rotate [ 00 : rota 01 : rota 10 : rota 11 : rota	te 0 de te90 d te 270	egree degre							

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
30	00	Х	X	Χ	Χ	X		_H byte Offset[3		
Description	Set the F	lorizont	tal offse	et						
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
31	00			_L	byte H	-Offset[7	7:0]			
Description	Set the F	Horizontal offset								

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
32	00	Х	Х	Х	Х	Х		_H byte V-Offset[3:0]		
Description	Set the V	ertical	offset							
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
33	00		_L byte V-Offset[7:0]							
Description	Set the V	Set the Vertical offset								

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
34	00		[7:4] ReservedH byte H-def[3:0]							
Description	[3:0] MS	B of in	nage h	orizonta	al phys	ical resc	lution i	n mem	nory	
Register Address (Hex)	Default (Hex)	DB7	DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0					Remark		
35	40	_L byte H-def[7:0]								
Description	[7:0] LSB	[7:0] LSB of image horizontal physical resolution in memory								

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Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
36	01		[7:4] ReservedH byte V-def[3:0]							
Description	[3:0] MS	BB of in	nage ve	ertical p	ohysica	ıl resolut	ion in r	nemor	У	
Register Address (Hex)	Default (Hex)	DB7	DB7 DB6 DB5 DB4 DB3 DB2					DB1	DB0	Remark
37	E0	_L byte V-def[7:0]								
Description	[7:0] LSE	7:0] LSB of image vertical physical resolution in memory								

The total RAM size is 640x240x18bit. The user can arrange the Horizontal ram size by REG[34],REG[35] and the Vertical ram size by REG[36],REG[37]. EX: 320x480x18bit REG[34]=0x01, REG[35]=0x40, REG[36]=0x01,

REG[37]=0xE0

EX: 640x240x18bit. REG[34]=0x02 , REG[35]=0x80 , REG[36]=0x00 , REG[37]=0xF0

# 10 Application Note:

```
void main(void)
{
 Initial_AMP506 ();
 Full_386SCR(0xf800);
 Full_386SCR(0x07e0);
 Full_386SCR(0x001f);
}
void AMP506_80Mode_Command_SendAddress(BYTE Addr)
 SET_nRD;
                        // /RD=1
 CLR_RS;
                        // RS=0
 CLR CS1;
                        // /CS=0
 CLR_nWRL;
                        // /WR=0
 DB16OUT(Addr);
                        // Data Bus OUT
 SET_nWRL;
                         ///WR=1
 SET_RS;
                        // RS=1
 SET_CS1;
                         // CS=1
}
```

```
void AMP506_80Mode_Command_SendData(BYTE Data)
{
 SET_nRD;
 SET_RS;
 CLR_CS1;
 CLR_nWRL;
 DB16OUT(Data);
 SET_nWRL;
 SET_RS;
 SET_CS1;
}
void AMP506_Command_Write(uint8 CMD_Address,uint8 CMD_Value)
{
 AMP506_80Mode_Command_SendAddress(CMD_Address);
 AMP506_80Mode_Command_SendData(CMD_Value);
}
void AMP506_80Mode_16Bit_Memory_SendData(uint16 Dat16bit)
 SET_nRD;
 SET_RS;
 CLR_CS1;
 CLR_nWRL;
  DB16OUT(Dat16bit>>8);
 SET_nWRL;
                               // Low to High Latch Data to AMP506 Buffer
 SET_CS1;
 SET_nRD;
 SET_RS;
 CLR_CS1;
 CLR_nWRL;
 DB16OUT(Dat16bit);
 SET_nWRL;
                               // Low to High Latch Data to AMP506 Buffer
 SET_CS1;
```

```
}
void Initial_AMP506(void)
{
  AMP506_Command_Write(0x40,0x12); /*[7:6] Reserved
                                          [5] PLL control pins to select out frequency range
                                          0: 20MHz ~ 100MHz 1: 100MHz ~ 300MHz
                                          [4] Reserved [3] Reserved
                                          [2:1] Output Driving Capability
                                          00: 4mA 01: 8mA 10: 12mA 11: 16mA
                                          [0] Output slew rate
                                          0: Fast 1: Slow
                                         */
AMP506_Command_Write(0x41,0x01);
                                             //Set PLL=40Mhz * (0x42) / (0x41)
AMP506_Command_Write(0x42,0x01);
                                           //0x41 [7:6] Reserved [5:0] PLL Programmable
                                          pre-divider, 6bit(1~63)
                                         //0x42 [7:6] Reserved [5:0] PLL Programmable loop
                                          divider, 6bit(1~63)
AMP506_Command_Write(0x00,0x00);
                                        // MSB of horizontal start coordinate value
AMP506_Command_Write(0x01,0x00);
                                           // LSB of horizontal start coordinate value
AMP506_Command_Write(0x02,0x01);
                                        // MSB of horizontal end coordinate value
AMP506_Command_Write(0x03,0x3F);
                                         // LSB of horizontal end coordinate value
          AMP506_Command_Write(0x04,0x00);
                                                   // MSB of vertical start coordinate value
          AMP506_Command_Write(0x05,0x00);
                                                     // LSB of vertical start coordinate value
          AMP506_Command_Write(0x06,0x01);
                                                   // MSB of vertical end coordinate value
          AMP506_Command_Write(0x07,0x3F);
                                                     // LSB of vertical end coordinate value
          AMP506_Command_Write(0x08,0x01);
                                                  // MSB of input image horizontal resolution
          AMP506_Command_Write(0x09,0x40);
                                                  // LSB of input image horizontal resolution
          AMP506_Command_Write(0x0a,0x00);
                                                  //[17:16] bits of memory write start address
          AMP506_Command_Write(0x0b,0x00);
                                                  //[15:8] bits of memory write start address
          AMP506_Command_Write(0x0c,0x00);
                                                  //[7:0] bits of memory write start address
AMP506_Command_Write(0x10,0x0D);
                                         /*[7] Output data bits swap
                                                                         0: Normal 1:Swap
                                     [6] Output test mode enable 0: disable 1: enable
                                     [5:4] Serial mode data out bus selection
                                     00: X_ODATA17 ~ X_ODATA12 active, others are set to
```

```
zero
                                     01: X_ODATA11 ~ X_ODATA06 active, others are set to
zero
                                     10: X ODATA05 ~ X ODATA00 active, others are set to
zero
                                     11: reserved
                                     [3] Output data blanking
                                     0: set output data to 0 1: Normal display
                                   [2] Parallel or serial mode selection
                                     0: serial data out
                                                            1: parallel data output
                                   [1:0] Output clock selection
                                   00: system clock divided by 2
                                   01: system clock divided by 4
                                   10: system clock divided by 8
                                   11: reserved */
         AMP506_Command_Write(0x11,0x05);
      /*[7] Reserved
        [6:4] Even line of serial panel data out sequence or data bus order of parallel panel
        000: RGB
                    001: RBG
                                 010: GRB 011: GBR 100: BRG 101: BGR Others:
reserved
        [3] Reversed
        [2:0] Odd line of serial panel data out sequence
        000: RGB 001: RBG
                                 010: GRB
                                              011: GBR 100: BRG 101: BGR Others:
          */
reserved
       AMP506_Command_Write(0x12,0x00);
                                               // [3:0] MSB of output H sync. pulse start
position
       AMP506 Command Write(0x13,0x00);
                                               //[7:0] LSB of output H sync. pulse start position
       AMP506_Command_Write(0x14,0x00);
                                               // [3:0] MSB of output H sync. pulse width
        AMP506_Command_Write(0x15,0x10);
                                                    //[7:0] LSB of output H sync. pulse width
        AMP506_Command_Write(0x16,0x00);
                                                    //[3:0] MSB of output DE horizontal start
position
        AMP506_Command_Write(0x17,0x38);
                                                    //[7:0] LSB of output DE horizontal start
position
     AMP506_Command_Write(0x18,0x01); //[3:0] MSB of output DE horizontal active region in
pixel
     AMP506_Command_Write(0x19,0x40);
                                              //[7:0] LSB of output DE horizontal active region
```

```
AMP506_Command_Write(0x1a,0x01);
                                               //[7:4] Reserved [3:0] MSB of output H total in
pixel
     AMP506 Command Write(0x1b,0xb8);
                                               //[7:0] LSB of output H total in pixel
     AMP506_Command_Write(0x1c,0x00);
                                                //[3:0] MSB of output V sync. pulse start
position
                                                //[7:0] of output V sync. pulse start position
     AMP506_Command_Write(0x1d,0x00);
     AMP506_Command_Write(0x1e,0x00);
                                                //[7:4] Reserved [3:0] MSB of output V sync.
pulse width
     AMP506 Command Write(0x1f,0x08);
                                                //[7:0] LSB of output V sync. pulse width
                                                // [3:0] MSB of output DE vertical start position
     AMP506_Command_Write(0x20,0x00);
                                                //[7:0] LSB of output DE vertical start position
     AMP506_Command_Write(0x21,0x12);
     AMP506 Command Write(0x22,0x00);
                                                // [3:0] MSB of output DE vertical active region
in line
     AMP506 Command Write(0x23,0xf0);
                                                //[7:0] LSB of output DE vertical active region
in line
     AMP506_Command_Write(0x24,0x01);
                                                //[7:4] Reversed [3:0] MSB of output V total in
line
     AMP506_Command_Write(0x25,0x09);
                                                //[7:0] LSB of output V total in line
     AMP506_Command_Write(0x26,0x00);
                                                // [17:16] bits of memory read start address
     AMP506 Command Write(0x27,0x00);
                                                //[7:0] [15:8] bits of memory read start address
     AMP506_Command_Write(0x28,0x00);
                                                //[7:0] [7:0] bits of memory read start address
    AMP506 Command Write(0x29,0x01);
    //[7:1] Reversed [0] Load output timing related setting (H sync., V sync. and DE) to take effect
   AMP506_Command_Write(0x2d,0x08); /* [7:4] Reserved
                                           [3] Output pin X_DCON level control
                                           [2] Output clock inversion
                                                                         0: Normal 1: Inverse
                                           [1:0] Image rotate
                                            00: 0° 01: 90° 10: 270° 11: 180°
   AMP506_Command_Write(0x30,0x00); //[7:4] Reserved [3:0] MSB of image horizontal shift
value
   AMP506_Command_Write(0x31,0x00); //[7:0] LSB of image horizontal shift value
   AMP506_Command_Write(0x32,0x00); //[7:4] Reserved [3:0] MSB of image vertical shift
value
   AMP506_Command_Write(0x33,0x00); //[7:0] LSB of image vertical shift value
   AMP506_Command_Write(0x34,0x01);
  // [3:0] MSB of image horizontal physical Resolution in memory
```

```
AMP506 Command Write(0x35,0x40);
  //[7:0] LSB of image horizontal physical resolution in memory
      AMP506 Command Write(0x36,0x01);
//[7:4] Reserved [3:0] MSB of image vertical physical resolution in memory
      AMP506 Command Write(0x37,0xe0);
//[7:0] LSB of image vertical physical resolution in memory
}
void AMP506_WindowSet(uint16 S_X,uint16 S_Y,uint16 E_X,uint16 E_Y)
          AMP506 80Mode Command SendAddress(0x00);
          AMP506_80Mode_Command_SendData((S_X)>>8);
          AMP506 80Mode Command SendData(S X);
          AMP506_80Mode_Command_SendData((E_X-1)>>8);
          AMP506_80Mode_Command_SendData(E_X-1);
          AMP506 80Mode Command SendData(S Y>>8);
          AMP506_80Mode_Command_SendData(S_Y);
          AMP506_80Mode_Command_SendData((E_Y-1)>>8);
          AMP506 80Mode Command SendData(E Y-1);
}
void Full 386SCR(uint16 Dat16bit)
{
  int32 k,I;
  AMP506 WindowSet(0,0,Resolution X,Resolution Y);
  AMP506_80Mode_Command_SendAddress(0xc1); //_DisplayRAM_WriteEnable_
 for(k=0;k<240*2;k++)
  {
   for(I=0;I<320;I++)
        AMP506_80Mode_16Bit_Memory_SendData(Dat16bit);
     }
  }
  AMP506_80Mode_Command_SendAddress(0x80); // DisplayRAM_WriteDisable _
}
```

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The TFT LCD controller default value is for AM320240N1 already. So we can start to write our data in a few steps:

Target: To write a 640x240 data to Display RAM and scroll the display data by change the Horizontal offset register.

10.1 Step 1: Make sure the interface Protocol.

10.2 Step 2: Define the Horizontal ram seize = 640 and Vertical ram size =240 640x240x18bit. REG[34]=0x02 , REG[35]=0x80 , REG[36]=0x00 ,

### REG[37]=0xF0

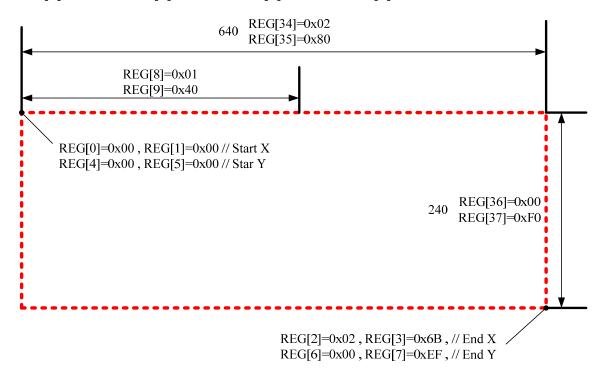
10.3 Step 3: Define the Panel X Size = 320

REG[8]=0x01, REG[9]=0x40

10.4 Step4: Define the Write window. Start=(0,0) End=(619,239)

REG[0] = 0x00 , REG[1] = 0x00 , REG[2] = 0x02 , REG[3] = 0x6B , // Start X , End X

REG[4]=0x00, REG[5]=0x00, REG[6]=0x00, REG[7]=0xEF, // Star Y, End Y



10.5 Step5: Write the 640x240x18 bit data consecutively



10.6 Step6: The display will show the following image.



10.7 Step7: Change the Horizontal offset to switch or scroll the display data. Set the Horizontal offset = 160, REG[30]=00 REG[31]=A0. You will see



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10.8 Step8: Change the Horizontal offset to switch or scroll the display data. Set the Horizontal offset = 320, REG[30]=01 REG[31]=40. You will see



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# DISPLAYED COLOR AND INPUT DATA

	Color & Gray								D	ATA S	SIGNA	L							
	Scale	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(0)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic Color	Blue(0)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(61)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Red	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Reu	Red(31)	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(1)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(0)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(62)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(61)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(31)	0	0	0	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(1)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green(0)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Blue	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(31)	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue(0)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

#### 11 QUALITY AND RELIABILITY

#### 11.1 TEST CONDITIONS

Tests should be conducted under the following conditions:

Ambient temperature :  $25 \pm 5^{\circ}$ C Humidity :  $60 \pm 25\%$  RH.

#### 11.2 SAMPLING PLAN

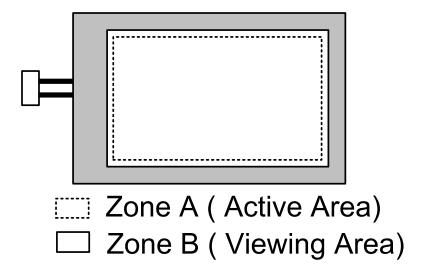
Sampling method shall be in accordance with MIL-STD-105E, level II, normal single sampling plan.

#### 11.3 ACCEPTABLE QUALITY LEVEL

A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

#### 11.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under flourescent light. The inspection area of LCD panel shall be within the range of following limits.



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# 11.5 INSPECTION QUALITY CRITERIA

No.	Item	Criterior	for de	fects	Defect type
1	Non display	No non display is allowed	Major		
2	Irregular operation	No irregular operation is a	allowed		Major
3	Short	No short are allowed			Major
4	Open	Any segments or commare rejectable.	on patte	rns that don't activate	Major
5	Black/White spot (I)	Size D (mm)  D ≤ 0.15  0.15 < D ≤ 0.20  0.20 < D ≤ 0.30  0.30 < D	Minor		
6	Black/White line (I)	Length(mm)         10 < L	Minor		
7	Black/White sport (II)	Size D (mm)  D ≤ 0.30  0.30 < D ≤ 0.50  0.50 < D ≤ 1.20  1.20 < D	Minor		
8	Black/White line (II)	Length (mm)     Width (       20 < L	Minor		
9	Back Light	No Lighting is rejectable     Flickering and abnormal	Major		
10	Display pattern	$\frac{A+B}{2} \le 0.30$ 0 < C  Note: 1. Acceptable up to 3 2. NG if there're to tw	Minor		

	Blemish &	-				
	Foreign matters	Size D (ı	mm)	Ac	ceptable number	
	. orongin manoro	D ≤ 0.1		710	Ignore	
11	Size:	0.15 < D < 0.2			3	Minor
		0.10 < D < 0.2			2	
	$D = \frac{A+B}{2}$	0.20 < D <u>&lt;</u> 0.3 0.30 < D	O		0	
	2	0.50 \ D			U	
			Length		Acceptable number	
		Width (mm)				
	Scratch on	W <u>&lt;</u> 0.0				
	Polarizer	3	L <u>,&lt;</u> 2		Ignore	
12		0.03 <w<u>&lt;0.05</w<u>	L > 2		1	Minor
'-	1 A .		L > 1		1	14111101
	A P	0.05 <w<u>&lt;0.08</w<u>	L <u>.&lt;</u> 1		Ignore	
	b		Note	(1)	Note(1)	
		0.08 <w< td=""><td></td><td></td><td></td><td></td></w<>				
		Note(1) Regard	as a blemis	<u>h</u>		
		Size D (ı	mm)	Ac	ceptable number	
4.0	Bubble in	D < 0.20			Ignore	
13	polarizer	0.20 < D ≤ 0.5			3	Minor
	<b>P</b> - 10.1	0.50 < D < 0.8			2	
		0.80 < D			0	
	Stains on	Stains that ca	nnot ha rai	moved a	ven when wiped lightly	
14	LCD panel		Minor			
	surface	WILLI a SUIL CIUI	ii oi siiiila	Clearing	g too are rejectable.	
15	Dust in Dozal	Dust which is	Minor			
15	Rust in Bezel	Rust which is	visible in tr	ie bezei i	is rejectable.	Minor
	Defect of					
	land surface					
16	contact (poor	Evident crevic	Minor			
	soldering)					
	0,					N.4 - '
	Parts	1. Failure to m				Major
17	mounting	2. Parts not in				Major
		3. Polarity, for	example, i	s reverse	ea	Major
		1. LSI, IC lea	d width is	more t	han 50% beyond pad	Minor
18	Parts	outline.				
10	alignment	<ol><li>Chip composite the leads i</li></ol>	Minor			
	0 1 1 '	1. 0.45<φ	,N≧1			Major
	Conductive	2. 0.30<φ <u>&lt;</u> 0.4	•			Minor
19	foreign matter	φ:Average				
	(Solder ball,	3. 0.50 <l< td=""><td>Minor</td></l<>	Minor			
	Solder chips)	L: Average				
					burnout, the pattern is	
			• •	•	re for repair; 2 or more	Minor
20	Faulty PCB		corrected			
	correction	•		•	no resist coating has	Minor
		been perfo	•	,	<b>5</b>	

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			panel may eptable nun				
21	Defect Dot	Bright dot	Dark dot	Total dot	Distance between Dark dark		Minor
		2	3	4	L≧5 mm		

# 12 Reliability test items (Note2):

No.	Test items	Conditions	Remark
1	High temperature storage	Ta=80°C 240Hrs	
2	Low temperature storage	Ta=-30°C 240Hrs	
3	High temperature operation	Ta=70°C 240Hrs	
4	Low temperature operation	Ta=-20°C 240Hrs	
5	High temperature and high humidity	Ta=40°C,85% RH 240Hrs	Operation
6	Heat shock	-30°C~80°C/200 cycles 1Hrs/cycle	Non-operation
7	Electrostatic discharge	±200V,200Pf(0Ω),once for each terminal	Non-operation
8	Vibration	Frequency range :8~33.3Hz Stoke :1.3mm Sweep :2.9G,33.3~400Hz Cycle :15 minutes 2 hours for each direction of X,Z 4 hours for Y direction	JIS C7021, A-10 Condition A
9	Mechanical shock	100G, 6ms,±X, ±Y,±Z 3 times for each direction	JIS C7021, A-7 Condition C
10	Vibration (With carton)	Random vibration: 0.015G <sup>2</sup> /Hz from 5~200Hz -6dB/octave from 200~500Hz	IEC 68~34
11	Drop (with carton)	Height:60cm 1 corner,3 edges,6 surfaces	JIS Z0202

# **13 USE PRECAUTIONS**

#### 13.1 Handling precautions

- 1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- 2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- 3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- 4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

#### 13.2 Installing precautions

- 1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx.  $1M\Omega$  and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- 2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- 3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- 4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

#### 13.3 Storage precautions

- 1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.

3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

#### 13.4 Operating precautions

- 1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- 2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- 3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- 4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- 5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- 6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
- 7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- 8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

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#### 13.5 Other

- 1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2) The residual image may exist if the same display pattern is shown for hours. This residual image, however, disappears when another display pattern is shown or the drive is interrupted and left for a while. But this is not a problem on reliability.

# 14 OUTLINE DIMENSION

# 14.1 OUTLINE DIMENSION-1 (With FFC P1.0x24 pins)

